



PENTA TVS/ZENER ARRAY FOR ESD AND LATCH-UP PROTECTION

This 5 TVS/Zener Array family have been designed to Protect Sensitive Equipment against ESD and to prevent Latch-Up events in CMOS circuitry operating at 5V, 12V, 15V and 24V. This TVS array offers an integrated solution to protect up to 5 data lines where the board space is a premium.

SPECIFICATION FEATURES

- 350W Power Dissipation (8/20µs Waveform)
- Low Leakage Current, Maximum of 5µA at rated voltage
- Very Low Clamping Voltage
- IEC61000-4-2 ESD 20kV air, 15kV Contact Compliance
- Industry Standard Surface Mount Package SOT23-6L
- 100% Tin Matte Finish (RoHS Compliant)

APPLICATIONS

- Personal Digital Assistant (PDA)
- SIM Card Port Protection (Mobile Phone)
- Portable Instrumentation
- Mobile Phones and Accessories
- Memory Card Port Protection

MAXIMUM RATINGS (Per Device)

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Device	Marking Code
PJSMS05C	MD5
PJSMS12C	MA2
PJSMS15C	MA5
PJSMS24C	MB4

SOT23-6L

Rating	Symbol	Value	Units
Peak Pulse Power (8/20µs Waveform)	P _{pp}	350	W
ESD Voltage (HBM)	V _{ESD}	>25	kV
Operating Temperature Range	TJ	-50 to +125	°C
Storage Temperature Range	T _{stg}	-50 to +150	°C

ELECTRICAL CHARACTERISTICS (Per Device) Tj = 25°C PJSMS05C

Parameter	Symbol	Conditions	Min	Typical	Max	Units
Reverse Stand-Off Voltage	V_{WRM}				5	V
Reverse Breakdown Voltage	V_{BR}	I _{BR} = 1mA	6			V
Reverse Leakage Current	I _R	V _R =5V			5	μΑ
Clamping Voltage (8/20µs)	Vc	I _{pp} = 5A			9.5	V
Clamping Voltage (8/20µs)	V _c	I _{pp} = 24A			13	V
Off State Junction Capacitance	Cj	0 Vdc Bias f = 1MHz Between I/O pins and pin 2			200	pF
Off State Junction Capacitance	Cj	5 Vdc Bias f = 1MHz Between I/O pins and pin 2			110	pF





ELECTRICAL CHARACTERISTICS (Per Device) Tj = 25°C PJSMS12C

Parameter	Symbol	Conditions	Min	Typical	Max	Units
Reverse Stand-Off Voltage	V_{WRM}				12	V
Reverse Breakdown Voltage	V_{BR}	I _{BR} =1mA	13.3			V
Reverse Leakage Current	I _R	V _R =12V			5	μΑ
Clamping Voltage (8/20µs)	V _c	I _{pp} =5A			17	V
Clamping Voltage (8/20µs)	V _c	I _{pp} = 15A			21	V
Off State Junction Capacitance	Cj	0 Vdc Bias f = 1MHz Between I/O pins and pin 2			90	pF

PJSMS15C

Parameter	Symbol	Conditions	Min	Typical	Max	Units
Reverse Stand-Off Voltage	V_{WRM}				15	V
Reverse Breakdown Voltage	V_{BR}	I _{BR} =1mA	16.7			V
Reverse Leakage Current	I _R	V _R = 15V			5	μΑ
Clamping Voltage (8/20µs)	Vc	I _{pp} =5A			22	V
Clamping Voltage (8/20µs)	V _c	I _{pp} = 12A			27	V
Off State Junction Capacitance	Cj	0 Vdc Bias f = 1MHz Between I/O pins and pin 2			70	pF

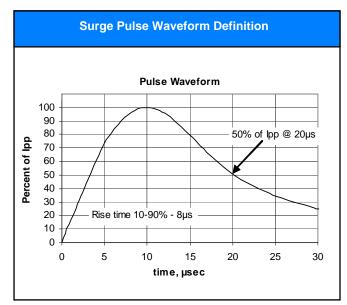
PJSMS24C

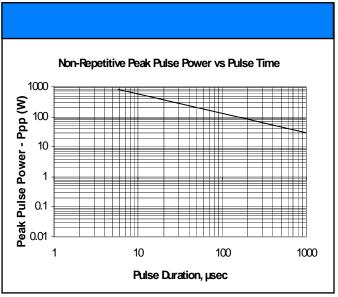
Parameter	Symbol	Conditions	Min	Typical	Max	Units
Reverse Stand-Off Voltage	V_{WRM}				24	V
Reverse Breakdown Voltage	V_{BR}	I _{BR} =1mA	26.7			V
Reverse Leakage Current	I _R	V _R = 24V			5	μΑ
Clamping Voltage (8/20µs)	Vc	I _{pp} =5A			35	V
Clamping Voltage (8/20µs)	V _c	I _{pp} = 8A			40	V
Off State Junction Capacitance	Cj	0 Vdc Bias f = 1MHz Between I/O pins and pin 2			50	pF

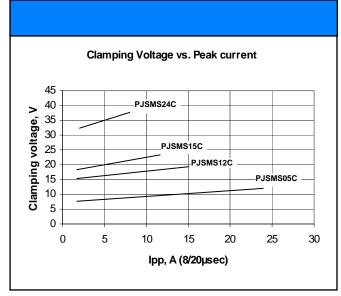


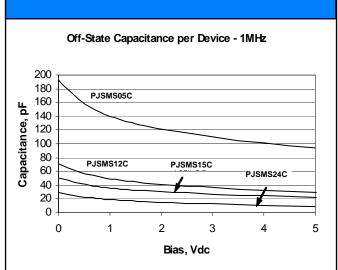


TYPICAL CHARACTERISTICS TJ = 25°C unless otherwise noted





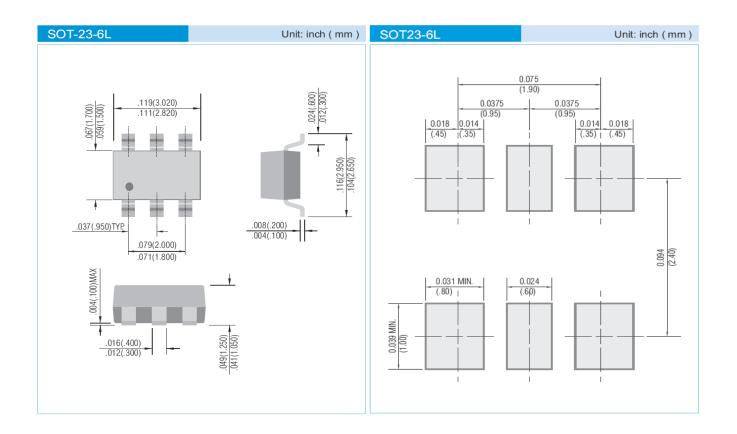








PACKAGE AND PAD LAYOUT DIMENSIONS



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